



GUR® 4122-5

GUR®

UHMW-PE powder grade: coarse particle

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Resin Identification	(PE-UHMW)		ISO 1043
Part Marking Code	>(PE-UHMW)<		ISO 11469
Average molecular weight	4.4E6 g/	/mol	Margolies' equation
Average particle size, d50	170 μr	m	laser scattering

Rheological properties

Viscosity number	2200 cm ³ /g	ISO 307, 1628
Intrinsic viscosity	1900	ISO 307, 1628

Typical mechanical properties

Tensile modulus	800	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	21	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	15	%	ISO 527-1/-2
Tensile stress at 50% strain	21	MPa	ISO 527-1/-2
Tensile stress at break, 50mm/min	41	MPa	ISO 527-1/-2
Nominal strain at break	380	%	ISO 527-1/-2
Elongational stress F, 150/10	0.24	MPa	ISO 21304-2
Poisson's ratio	0.46 ^[C]		
Shore D hardness, 15s	60		ISO 48-4 / ISO 868
[C]: Calculated			

Thermal properties

Temperature of deflection under load, 1.8 MPa	41 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h 50N	80 °C	ISO 306

Electrical properties

Volume resistivity	1E12 Ohm.m	IEC 62631-3-1
Surface resistivity	1E12 Ohm	IEC 62631-3-2

Physical/Other properties

Density	930 kg/m³	ISO 1183
Bulk density	410 kg/m³	ISO 60

Characteristics

Processing Compression moulding, Porous Sintering

Delivery form Powder

Special characteristics High impact or impact modified, Hydrolysis resistant, Low wear / Low friction,

Chemical resistant

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Revised: 2024-08-22 Source: Celanese Materials Database

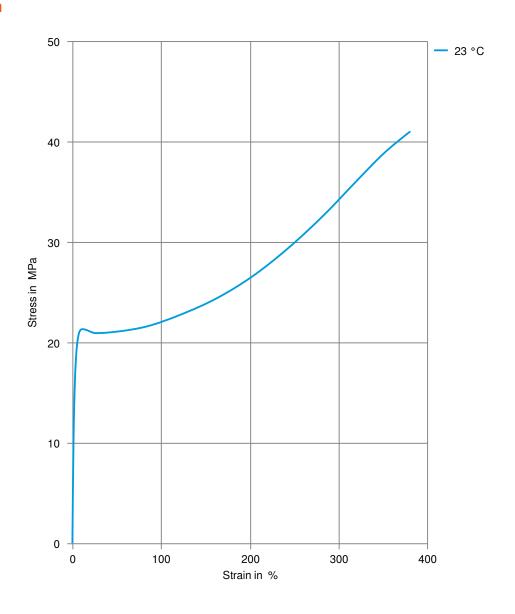




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Stress-strain



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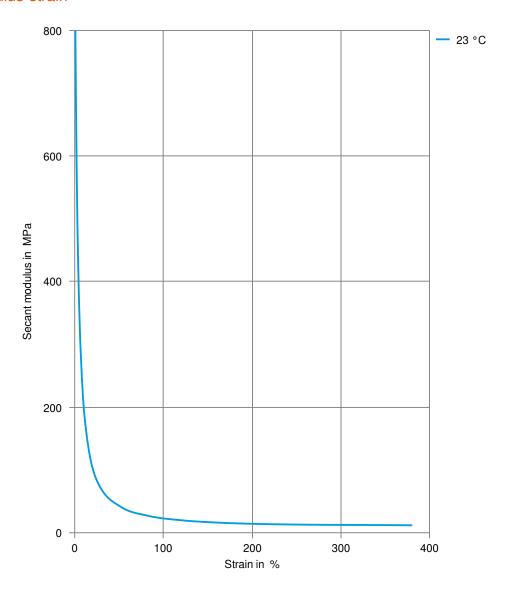
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Secant modulus-strain



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